

4.5Ω Quad SPDT Analog Switch 4-Channel 2:1 Multiplexer – Demultiplexer With Two Controls

FEATURES

High Bandwidth: 300MHzHigh Speed, Typically 30ns

• Supply Range: +1.8V to +5.5V

Low ON-State Resistance, 4.5Ω(TYP)

• Break-Before-Make Switching

• Rail-to-Rail Operation

• TTL/CMOS Compatible

 Extended Industrial Temperature Range: -40°C to +125°C

APPLICATIONS

- Video Switching
- Relay Replacements
- USB Switching
- Battery-Operated Equipment
- Cell Phones

FUNCTION TABLE

IN1-2	NO1 and NO2	NC1 and NC2
0	OFF	ON
1	ON	OFF

IN3-4	NO3 and NO4	NC3 and NC4
0	OFF	ON
1	ON	OFF

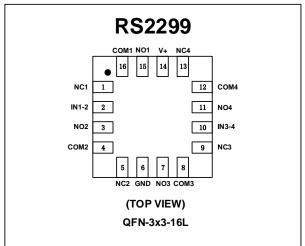
DESCRIPTION

The RS2299 is a bidirectional 4-channel single-pole double-throw (SPDT) analog switch with two control inputs, which is designed to operate from 1.8V to 5.5V. This device is also known as a 2 channel double-pole double-throw (DPDT) configuration.

The RS2299 device can handle both analog and digital signals. It features hign-bandwidth(300MHz) and low on-resistance (4.5Ω TYP).

Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-to-analog conversion systems.

PIN CONFIGURATIONS



PIN DESCRIPTION

NAME	PIN	FUNCTION	
V+	14	Power Supply	
GND	6	Ground	
IN1-2	2	Digital Control Pin	
IN3-4	10	Digital Control Pin	
COMx	16,4,8,12	Common Terminal	
NOx	15,3,7,11	Normally-Open Terminal	
NCx	1,5,9,13	Normally-Closed Terminal	



ABSOLUTE MAXIMUM RATINGS (1)

V+, IN to GND	0.3V to 6.0V
Analog, Digital Voltage Range (2)	- 0.3 to (V+) + 0.3V
Continuous Current NO, NC, or COM	±300mA
Peak Current NO, NC, or COM	±500mA
Storage Temperature	. −65°C to +150°C
Operating Temperature	. −40°C to +125°C
Junction Temperature	150°C
Package Thermal Resistance @ TA = +2	25°C
SOT23-5, SOT23-6	200°C/W
MSOP-10, SOIC-8 ,TSSOP-8	150°C/W
QFN-3x3-16L	100°C/W
Lead Temperature (Soldering, 10s)	260°C
ESD Susceptibility	
HBM	1000V
MM	

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
- (2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.3V beyond the supply rails should be current-limited to 10mA or less.

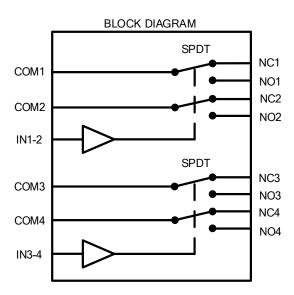


ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION

PRODUCT	ORDERING NUMBER	RANGE PACKAGE LEAD		PACKAGE MARKING	PACKAGE OPTION
RS2299	RS2299XTQC16	-40°C~125°C	QFN3x3-16L	RS2299	Tape and Reel,3000





ELECTRICAL CHARACTERISTICS

V+ = 5.0 V, $T_A = -40 ^{\circ}\text{C}$ to 125 $^{\circ}\text{C}$ (unless otherwise noted))

PARAMETER	SYMBOL	CONDITIONS	V+	T _A	MIN	TYP	MAX	UNITS
ANALOG SWITCH								
Analog Signal Range	Vno, Vnc, Vcom			FULL	0		V+	V
		V_{NO} or $V_{NC} = V+/2$,	5V	+25°C		4.5	8	Ω
On Desistance	_		οv	FULL			8.5	Ω
On-Resistance	Ron	I _{COM} = -10mA, Switch ON, See Figure 1	3.3V	+25°C		7	10	Ω
			3.30	FULL			10.5	Ω
			5V	+25°C		0.15	0.3	Ω
On-Resistance Match	A D	V_{NO} or $V_{NC} = V + /2$,	οv	FULL			0.4	Ω
Between Channels	ΔRon	I _{COM} = -10mA, Switch ON, See Figure 1	2.21/	+25°C		0.15	0.3	Ω
	3.	3.3V	FULL			0.4	Ω	
			5V	+25°C		2	3	Ω
On Desistance Flatness	RFLAT(ON)	$0 \leqslant (V_{NO} \text{ or } V_{NC}) \leqslant V+/2,$ $I_{COM} = -10 \text{mA}, \text{ Switch ON},$ See Figure 1	50	FULL			3.3	Ω
On-Resistance Flatness			re 1 +25°C	+25°C		3	4	Ω
				FULL			4.3	Ω
NC,NO OFF Leakage Current	Inc(off), Ino(off)	V _{NO} or V _{NC} = 0.3V, V+/2 V _{COM} = V+/2, 0.3V See Figure 2	1.8 to 5.5V	FULL			1	μΑ
NC,NO,COM ON Leakage Current	Inc(on), Ino(on), Icom(on)	V _{NO} or V _{NC} = 0.3V, Open V _{COM} = Open, 0.3V See Figure 2	1.8 to 5.5V	FULL			1	μΑ
DIGITAL CONTROL INP	PUTS ⁽¹⁾		•	•				
	.,		5V	FULL	1.5			V
Input High Voltage	Vinh		3.3V	FULL	1.3			V
			5V	FULL			0.6	V
Input Low Voltage	VINL		3.3V	FULL			0.5	V
Input Leakage Current	lin	Vin = Vio or 0	1.8 to 5.5V	FULL			1	μΑ

⁽¹⁾ All unused digital inputs of the device must be held at Vio or GND to ensure proper device operation.

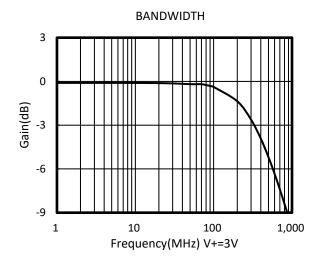


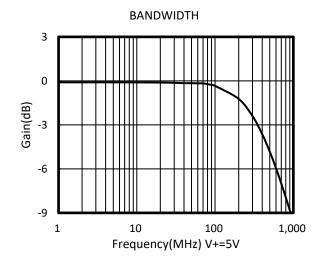
ELECTRICAL CHARACTERISTICS (continued) V+ = 5.0 V, TEMP= -40°C to 125°C (unless otherwise noted))

PARAMETER	SYMBOL	CONDITIONS		V+	TEMP	MIN	TYP	MAX	UNITS
DYNAMIC CHARACTERISTICS									
Turn-On Time	ton	$V_{COM} = V+, R_L = 300\Omega, C_L = 35pF,$		5V	+25°C		30		ns
Tulli-Oli fillic	ton	See Figure 5		3.3V	+25 C		40		115
Turn-Off Time	toff		$V_{COM} = V_{+}, R_{L} = 300\Omega, C_{L} = 35pF,$		+25°C		25		ne
Turr-On Time	torr	See Figure 5		3.3V	+23 C		30		ns
Break-Before-Make		Vno1 = Vnc1 = Vno2 = Vnc2 =	- ,	5V			5		
Time Delay	t _{BBM}	$R_L = 300\Omega$, $C_L = 35pF$, See Figure 6		3.3V	+25°C		8		ns
Off Isolation	0	R_L = 50Ω, Switch OFF,	f = 10MHz		+25°C		-52		dB
	Oiso	See Figure 8	f = 1MHz		+25°C	;	-71		dB
-3dB Bandwidth	BW	Switch ON, $R_L = 50\Omega$ See Figure 7			+25°C		300		MHz
NC,NO OFF Capacitance	CNC(OFF), CNO(OFF)	V _{NC} or V _{NO} =V+/2 or GND, Switch OFF See Figure 4			+25°C		5		pF
NC,NO,COM ON Capacitance	CNC(ON), CNO(ON), CCOM(ON)	V _{NC} or V _{NO} =V+/2 or GND, Switch ON See Figure 4			+25°C		15		pF
POWER REQUIREMENTS									
Power Supply Range	V+				FULL	1.8		5.5	V
Power Supply Current	I ₊	V _{IN} = GND or V ₊		5.5V	FULL			1	μΑ

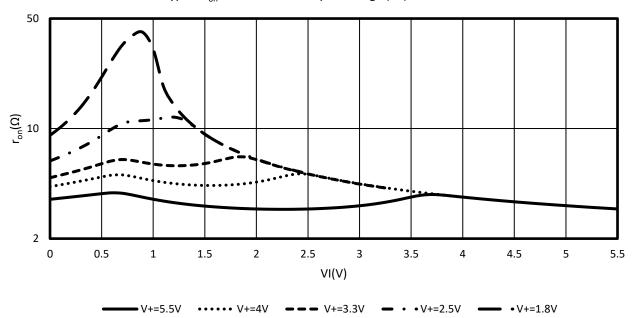


TYPICAL CHARACTERISTICS





Typical r_{on} as a Function of Input Voltage (VI) for VI = 0 to V+





Parameter Measurement Information

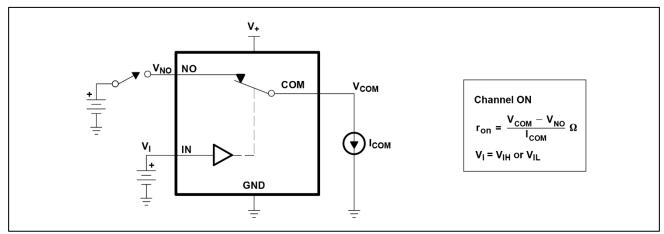


Figure 1.ON-State Resistance (ron)

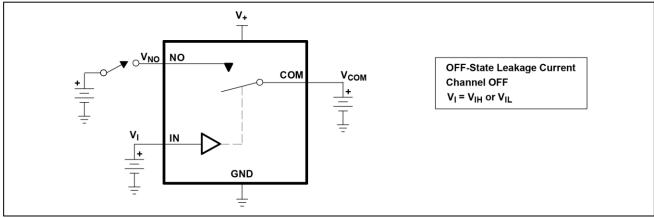


Figure 2.OFF-State Leakage Current (ICOM(OFF), INO(OFF))

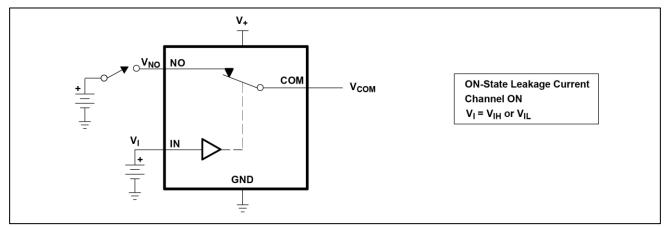


Figure 3.ON-State Leakage Current (ICOM(ON), INO(ON))

6

www.run-ic.com



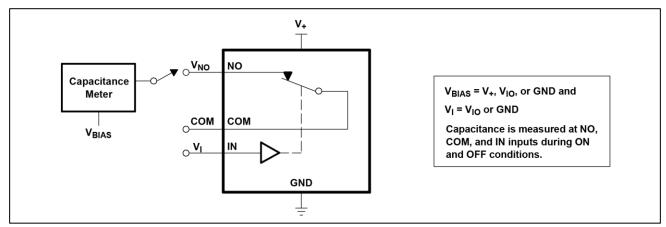


Figure 4. Capacitance (CI, CCOM(OFF), CCOM(ON), CNO(OFF), CNO(ON))

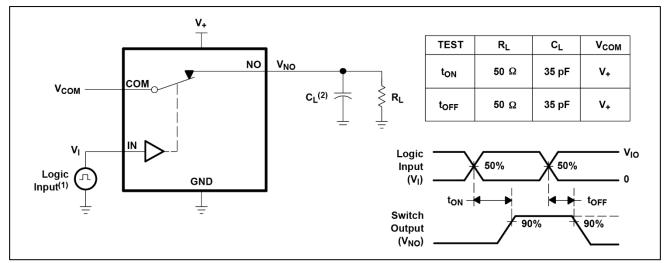


Figure 5.Turn-On (ton) and Turn-Off Time (toff)

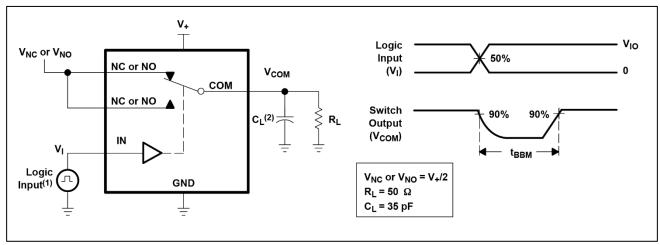


Figure 6.Break-Before-Make Time (t_{BBM})



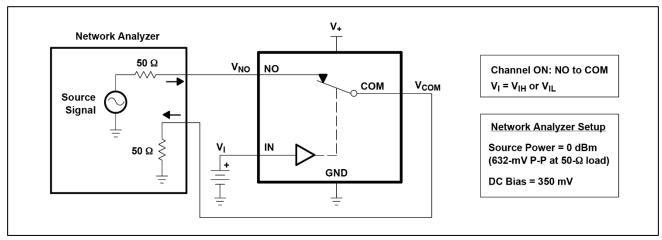


Figure 7.Bandwidth (BW)

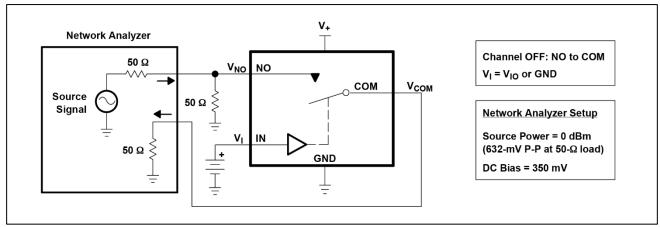


Figure 8.OFF Isolation (O_{ISO})

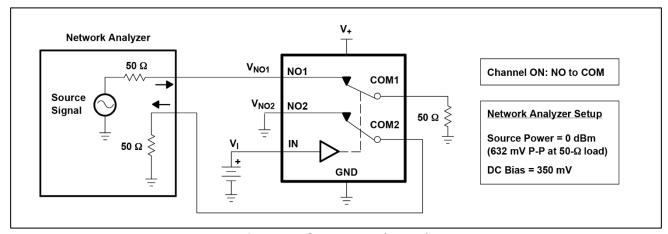


Figure 9.Crosstalk (XTALK)

8

www.run-ic.com



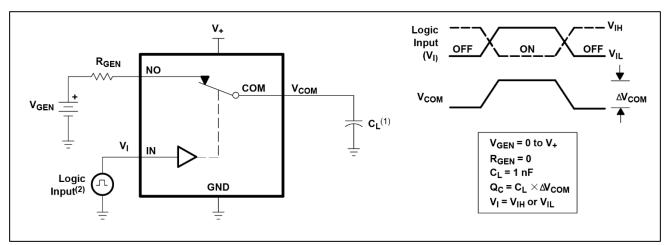


Figure 10.Charge Injection (Qc)

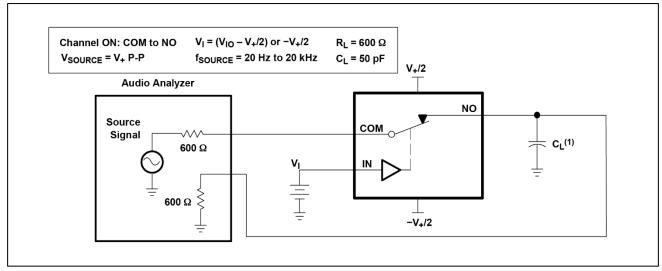
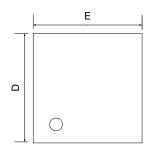


Figure11.Total Harmonic Distortion (THD)

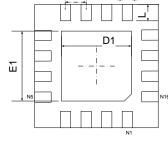
9



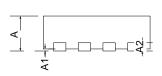
PACKAGE OUTLINE DIMENSIONS $QFN\hbox{-}3x3\hbox{-}16L$



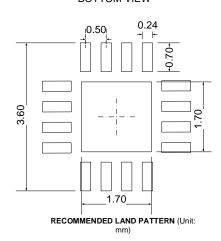
TOP VIEW



BOTTOM VIEW



SIDE VIEW



Symbol	Dimensions	In Millimeters	Dimension	s In Inches		
	Min	Max	Min	Max		
А	0.700	0.800	0.028	0.031		
A1	0.000	0.050	0.000	0.002		
A2	0.2	203	0.008			
b	0.180	0.300	0.007	0.012		
D	2.900	3.100	0.114	0.122		
D1	1.600	1.800	0.063	0.071		
Е	2.900	3.100	0.114	0.122		
E1	1.600	1.800	0.063	0.071		
е	0.500) TYP	0.020) TYP		
L	0.300	0.500	0.012	0.020		